

## NCE N-Channel Enhancement Mode Power MOSFET

### DESCRIPTION

The NCE75H21T uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in Automotive applications and a wide variety of other applications.

### GENERAL FEATURES

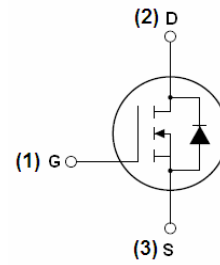
- $V_{DSS} = 75V, I_D = 210A$   
 $R_{DS(ON)} < 4m\Omega @ V_{GS} = 10V$
- Good stability and uniformity with high  $E_{AS}$
- Special process technology for high ESD capability
- High density cell design for ultra low  $R_{dson}$
- Fully characterized Avalanche voltage and current
- Excellent package for good heat dissipation

### Application

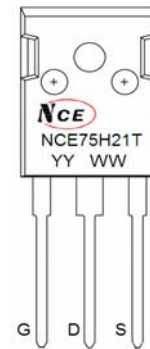
- Automotive applications
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

**100% UIS TESTED!**

**100%  $\Delta V_d$ s TESTED!**



Schematic diagram



Marking and pin Assignment



TO-247 top view

### Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE75H21T	NCE75H21T	TO-247	-	-	-

### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DSS}$	75	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	210	A
Drain Current-Continuous( $T_c=100^\circ C$ )	$I_D(100^\circ C)$	150	A
Pulsed Drain Current	$I_{DM}$	850	A
Maximum Power Dissipation	$P_D$	480	W
Derating factor		3.2	W/°C

Single pulse avalanche energy (Note 3)	$E_{AS}$	2200	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	5	V/ns
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 175	°C

### Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 1)	$R_{\theta JC}$	0.31	°C/W
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### Electrical Characteristics (TA=25°C unless otherwise noted)

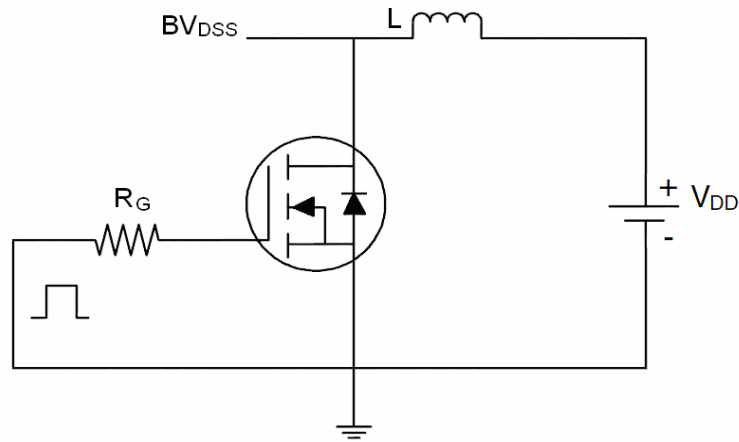
Parameter	Symbol	Condition	Min	Typ	Max	Unit	
<b>Off Characteristics</b>							
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	75	-	-	V	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=75V, V_{GS}=0V$	-	-	1	μA	
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±200	nA	
<b>On Characteristics</b>							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	3	4	V	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=40A$	25°C	-	2.9	4	mΩ
			125°C	-	4.7	6.5	mΩ
Forward Transconductance	$g_{FS}$	$V_{DS}=25V, I_D=40A$	100	165	-	S	
<b>Dynamic Characteristics</b>							
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V,$ $F=1.0MHz$	-	12100	-	PF	
Output Capacitance	$C_{oss}$		-	2000	-	PF	
Reverse Transfer Capacitance	$C_{rss}$		-	480	-	PF	
<b>Switching Characteristics</b>							
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=38V, I_D=40A$ $V_{GS}=10V, R_{GEN}=1.2\Omega$ (Note2)	-	20	-	nS	
Turn-on Rise Time	$t_r$		-	190	-	nS	
Turn-Off Delay Time	$t_{d(off)}$		-	130	-	nS	
Turn-Off Fall Time	$t_f$		-	120	-	nS	
Total Gate Charge	$Q_g$	$V_{DS}=60V, I_D=40A,$ $V_{GS}=10V$ (Note2)	-	410	620	nC	
Gate-Source Charge	$Q_{gs}$		-	90	140	nC	
Gate-Drain Charge	$Q_{gd}$		-	140	210	nC	
<b>Drain-Source Diode Characteristics</b>							
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=40A$	-	-	1.2	V	
Reverse Recovery Time	$t_{rr}$	$T_J = 25^\circ C, I_F = 40A$ $di/dt = 100A/\mu s$ (Note2)	-	120	210	nS	
Reverse Recovery Charge	$Q_{rr}$		-	860	1300	nC	
Forward Turn-On Time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)					

### Notes:

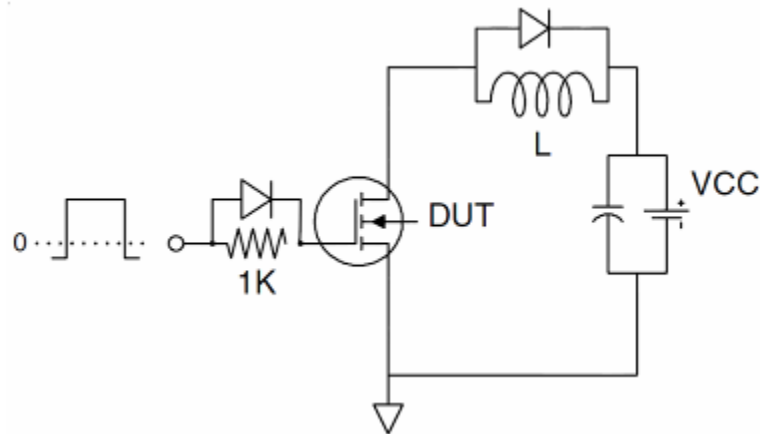
- Surface Mounted on FR4 Board,  $t \leq 10$  sec.
- Pulse Test: Pulse Width  $\leq 400\mu s$ , Duty Cycle  $\leq 2\%$ .
- EAS condition:  $T_J=25^\circ C, V_{DD}=37.5V, V_G=10V, L=2mH, R_g=25\Omega, I_{AS}=37A$
- $I_{SD} \leq 125A, di/dt \leq 260A/\mu s, V_{DD} \leq V_{(BR)DSS}, T_J \leq 175^\circ C$

## Test circuit

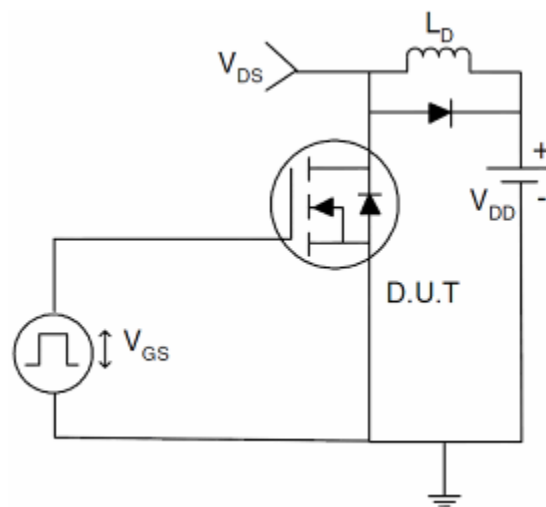
### 1) E<sub>AS</sub> test Circuits



### 2) Gate charge test Circuit:



### 3) Switch Time Test Circuit:



## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

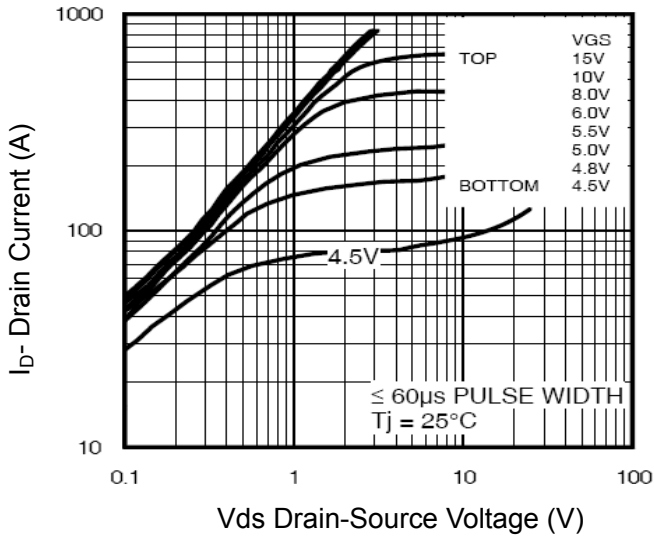


Figure 1 Output Characteristics

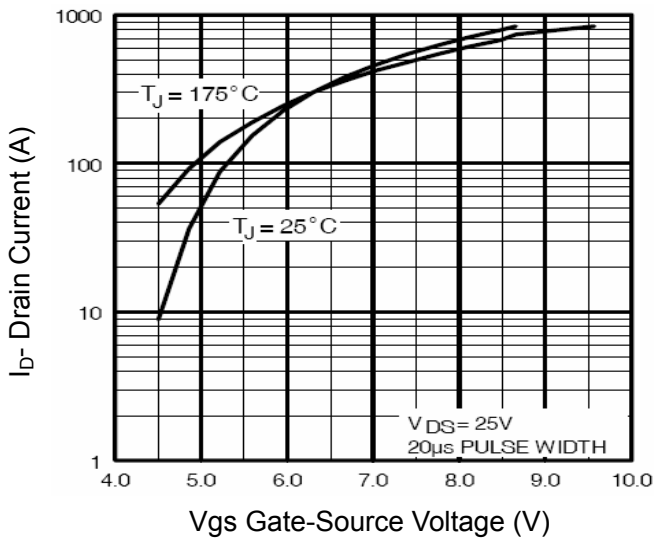


Figure 2 Transfer Characteristics

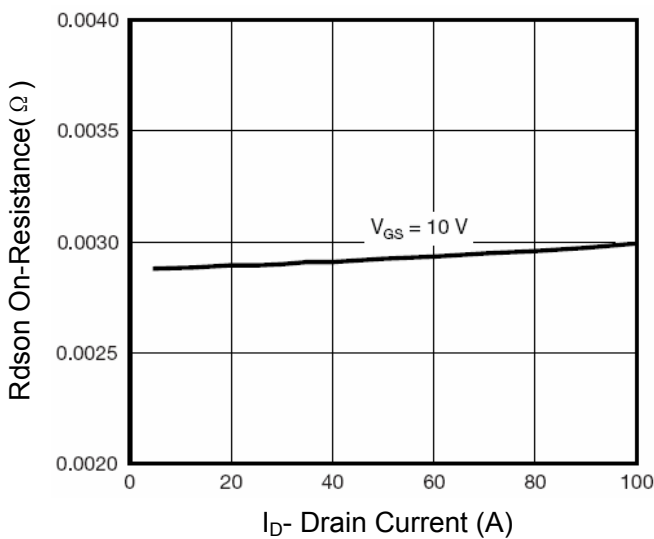


Figure 3  $R_{DS(on)}$ - Drain Current

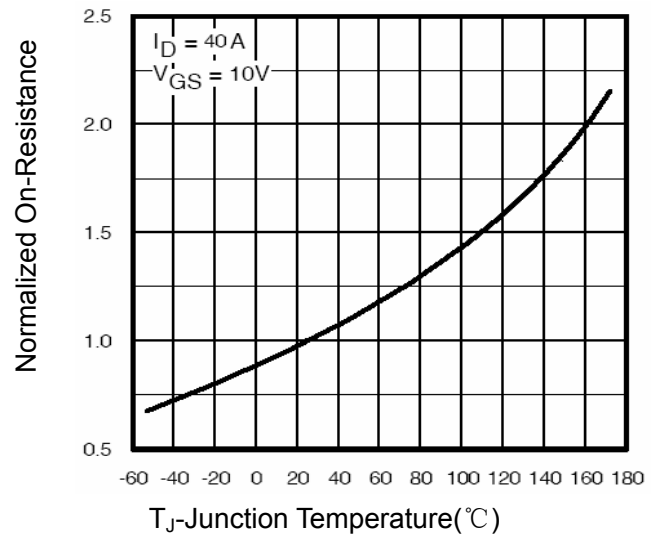


Figure 4  $R_{DS(on)}$ -Junction Temperature

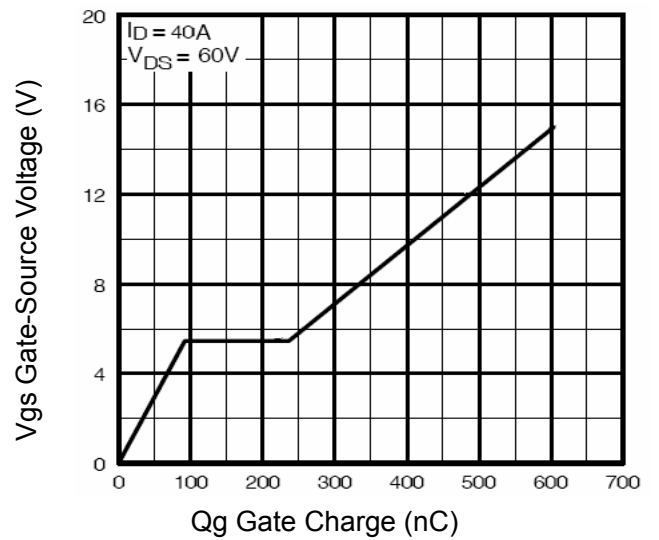


Figure 5 Gate Charge

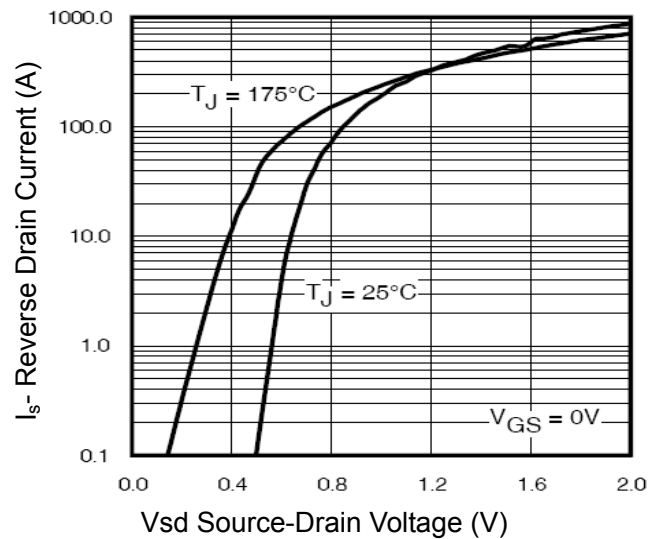


Figure 6 Source- Drain Diode Forward

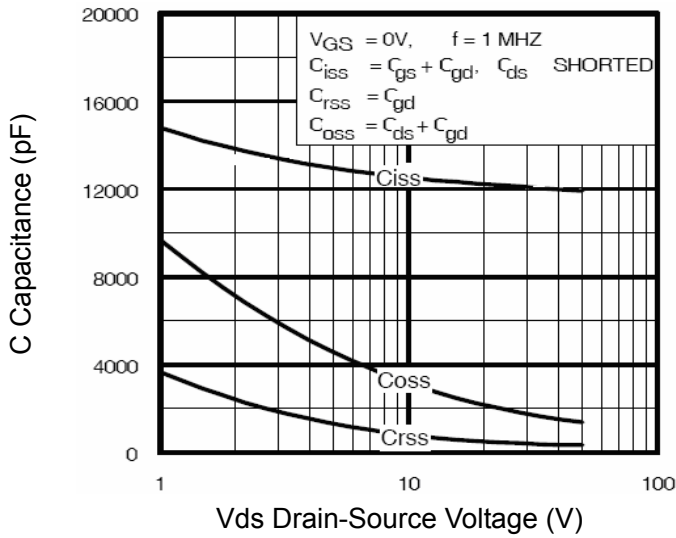


Figure 7 Capacitance vs Vds

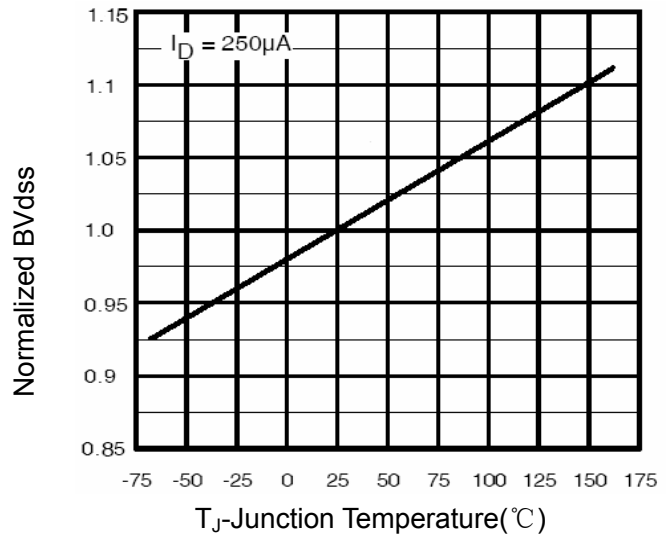


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

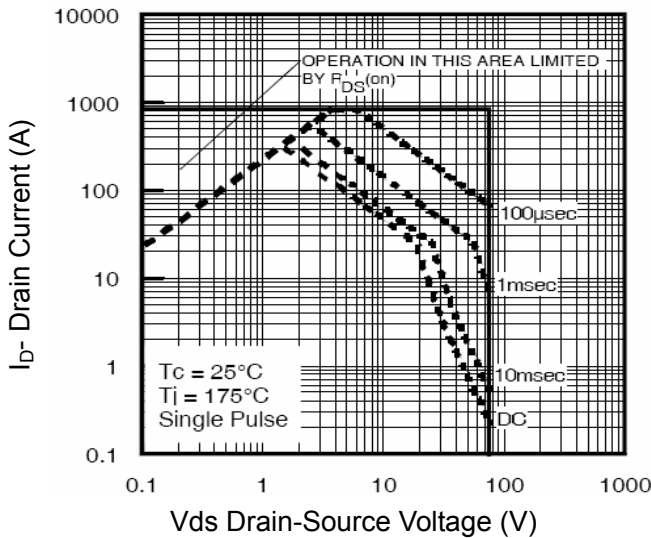


Figure 8 Safe Operation Area

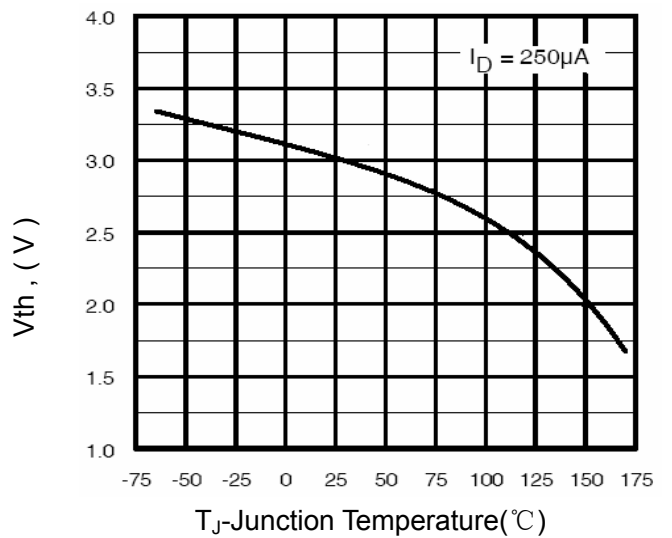


Figure 10 V<sub>GS(th)</sub> vs Junction Temperature

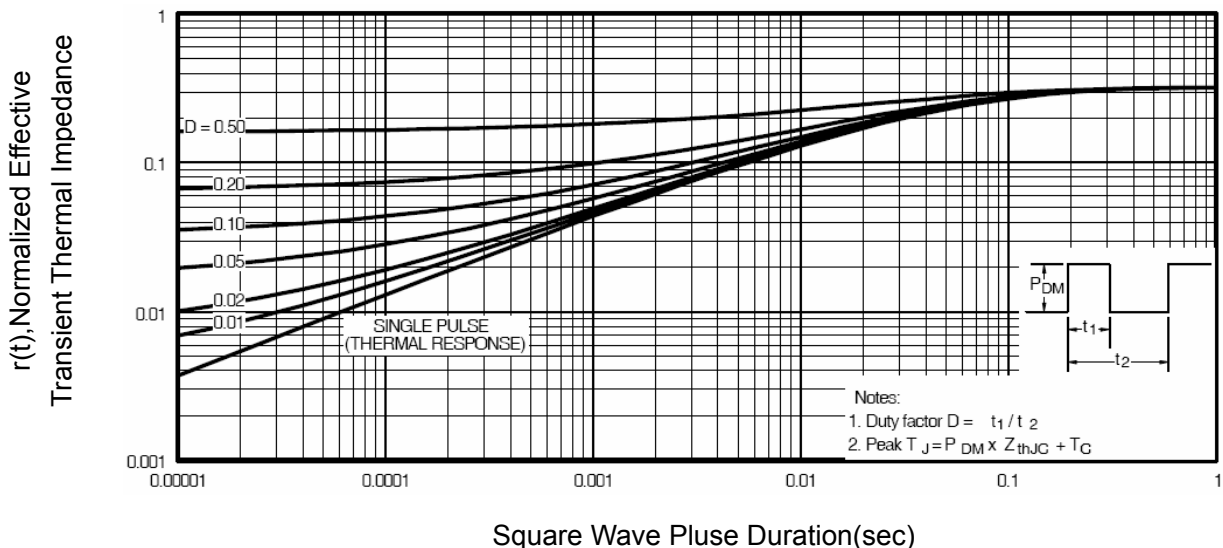
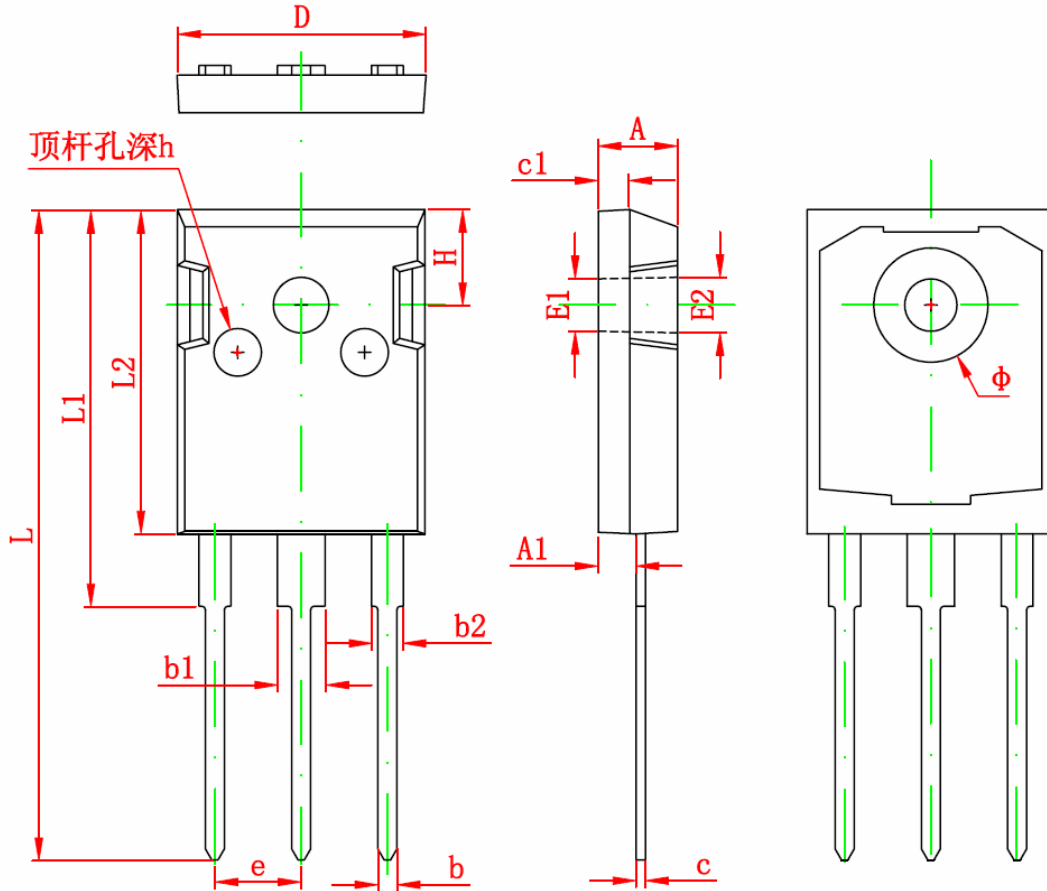


Figure 11 Normalized Maximum Transient Thermal Impedance

## TO-247 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.850	5.150	0.191	0.200
A1	2.200	2.600	0.087	0.102
b	1.000	1.400	0.039	0.055
b1	2.800	3.200	0.110	0.126
b2	1.800	2.200	0.071	0.087
c	0.500	0.700	0.020	0.028
c1	1.900	2.100	0.075	0.083
D	15.450	15.750	0.608	0.620
E1	3.500REF		0.138REF	
E2	3.600REF		0.142REF	
L	40.900	41.300	1.610	1.626
L1	24.800	25.100	0.976	0.988
L2	20.300	20.600	0.799	0.811
Φ	7.100	7.300	0.280	0.287
e	5.450TYP		0.215TYP	
H	5.980TYP		0.235 REF	
h	0.000	0.300	0.000	0.012

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